

REV	MODIFICATION
A	EC05325
B	EC06731

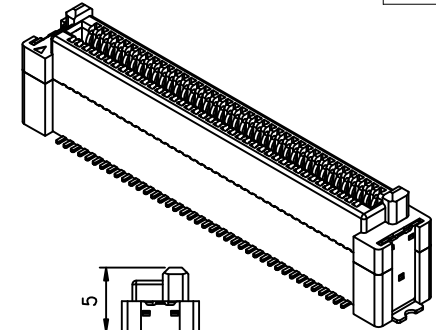
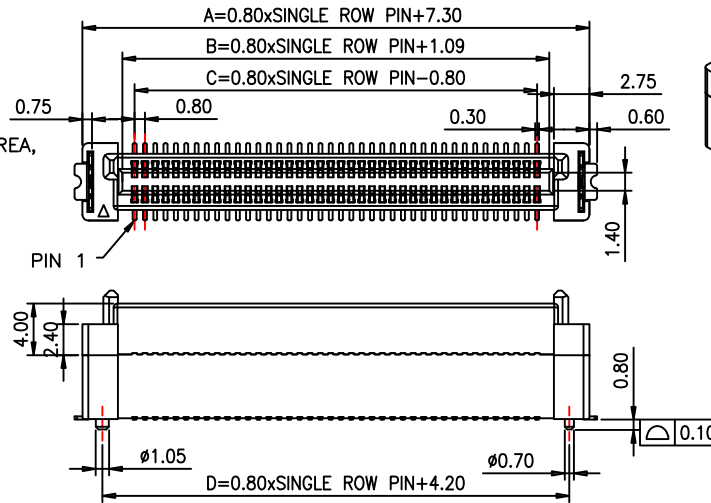
NOTES:

1. FINISH:

- 1.1 HOUSING: LCP BLACK,UL94V-0.
- 1.2 CONTACT: PHOSPHOR BRONZE,GOLD (SEE P/N) PLATED IN CONTACT AREA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA, 50u" MIN. NICKEL UNDERPLATED OVERALL.
- 1.3 GROUND: BRASS,80u" MIN. MATTE TIN PLATED OVER 50u" MIN. NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:

- 2.1 CURRENT RATING:0.5A;
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC/MINUTE.
- 2.3 CONTACT RESISTANCE: 50mΩ MAX.
- 2.4 INSULATION RESISTANCE: 1000MΩ MIN.
- 2.5 OPERATION TEMPERATURE:-40°C TO +105°C.

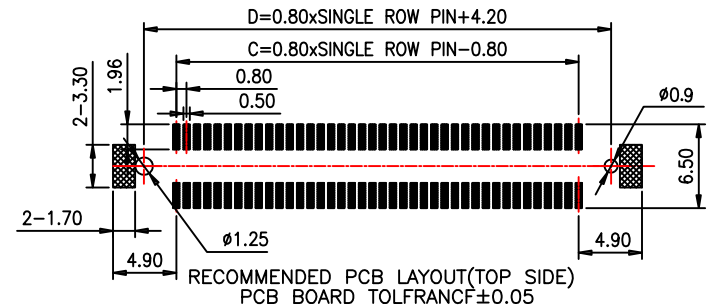
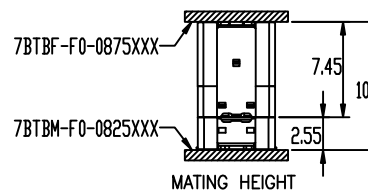
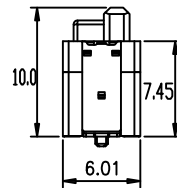
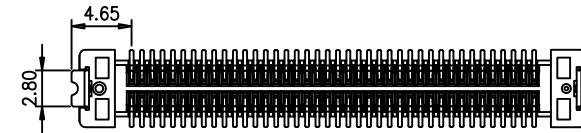


7BTBF-F0-0875XXX

TABLE1:

PIN NO:EX:40PIN-040 ; 50PIN-050...

No. OF PIN	A	B	C	D
040:2x20PIN	23.30	17.09	15.20	20.20
050:2x25PIN	27.30	21.09	19.20	24.20
060:2x30PIN	31.30	25.09	23.20	28.20
080:2x40PIN	39.30	33.09	31.20	36.20
140:2x70PIN	63.30	57.09	55.20	60.20



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5 °	名 稱(TITLE) 0.8 PITCH BTB SOCKET H:7.45 MATING HEIGHT 10.0	
.X± 0.30	.X*± 2 °		
.XX± 0.20	.XX*± 1 °		
單 位(UNIT) mm	料 號(PART NO) 7BTBF-F0-0875XXX	圖 號(DWG NO) 7BTBF-F0-0875XXX	圖 號(SHEET) 1 / 1
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	圖 號(SCALE) 1:1
			圖 號(REV) B

